

1.5 Amp. Glass Passivated Bridge Rectifier

<p>Dimensions in mm.</p> <p>Plastic Case</p> <p>• Mounting Instructions</p> <ul style="list-style-type: none"> • High temperature soldering guaranteed: 260 °C – 10 sc. • Recommended mounting torque: 8 Kg.cm. 	<p>Voltage 100 to 1000 V.</p> <p>Current 1.5 A.</p>
	<p>• Glass Passivated Junction Chips.</p> <ul style="list-style-type: none"> • UL recognized under component index file number E130180. • Lead and polarity identifications. • Case: Molded Plastic. • Ideal for printed circuit board (P.C.B.). • The plastic material carries U/L recognition 94 V-O.

Maximum Ratings, according to IEC publication No. 134

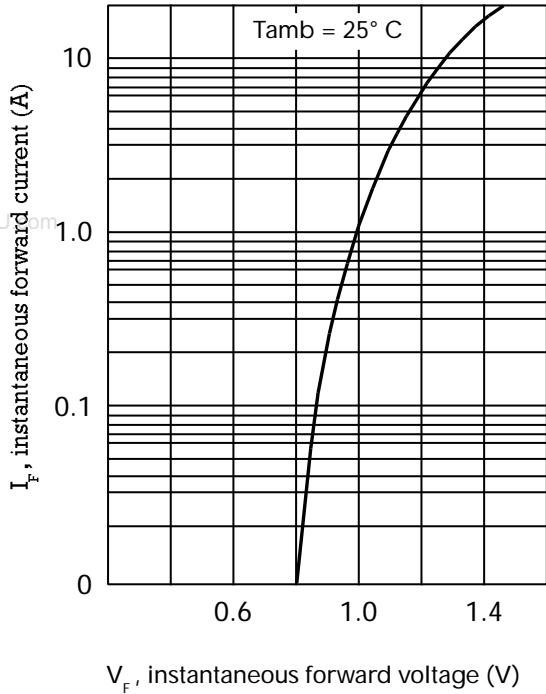
	FBI1.5B 5S2	FBI1.5D 5S2	FBI1.5F 5S2	FBI1.5J 5S2	FBI1.5L 5S2	FBI1.5M 5S2
V_{RRM}	Peak Recurrent Reverse Voltage (V)					
V_{RMS}	Maximum RMS Voltage (V)					
V_R	Recommended Input Voltage (V)					
$I_{F(AV)}$	Max. Average forward current with heatsink without heatsink					
I_{FRM}	Recurrent peak forward current					
I_{FSM}	10 ms. peak forward surge current					
I^2t	I^2t value for fusing (t = 10 ms)					
V_{DIS}	Dielectric strength (terminals to case, AC 1 min.)					
T_j	Operating temperature range					
T_{stg}	Storage temperature range					

Electrical Characteristics at Tamb = 25°C

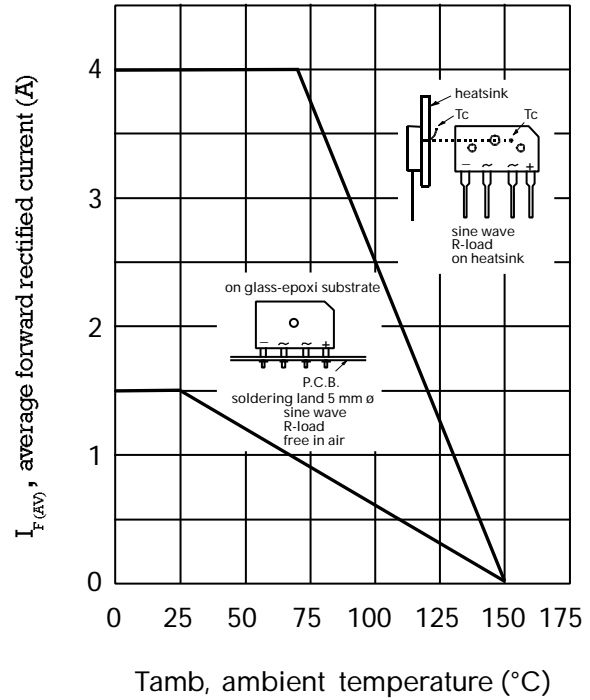
V_F	Max. forward voltage drop per element at $I_F = 1 A$	1.1 V
I_R	Max. reverse current per element at V_{RRM}	5 μA
$R_{th(j-c)}$	MAXIMUM THERMAL RESISTANCE Junction-Case. With Heatsink.	12 °C/W
$R_{th(j-a)}$	Junction-Ambient. Without Heatsink.	45 °C/W

Characteristic Curves

TYPICAL FORWARD CHARACTERISTIC



FORWARD CURRENT DERATING CURVE



MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

